

CUSTOMER: _____

DATE: _____

APPROVAL SPECIFICATION

PRODUCT NAME: SMD power inductor

CUSTOMER PART NO.:

OUR PART NO.: MPIT6045 Series

RECEPTION THE SPECIFICATION HAS BEEN ACCEPTED.		
COMPANY:		DATE:
CFMD	CHKD	RCVD

MANUFACTURING NAME

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Component SPEC Version Record

Rev.	Effective Date	Changed Contents	Change Reasons	Approved By
01	Dec. 10.2012	New released	/	Charles

1. Scope

This specification applies to the MPIT6045 series of SMD power inductor.

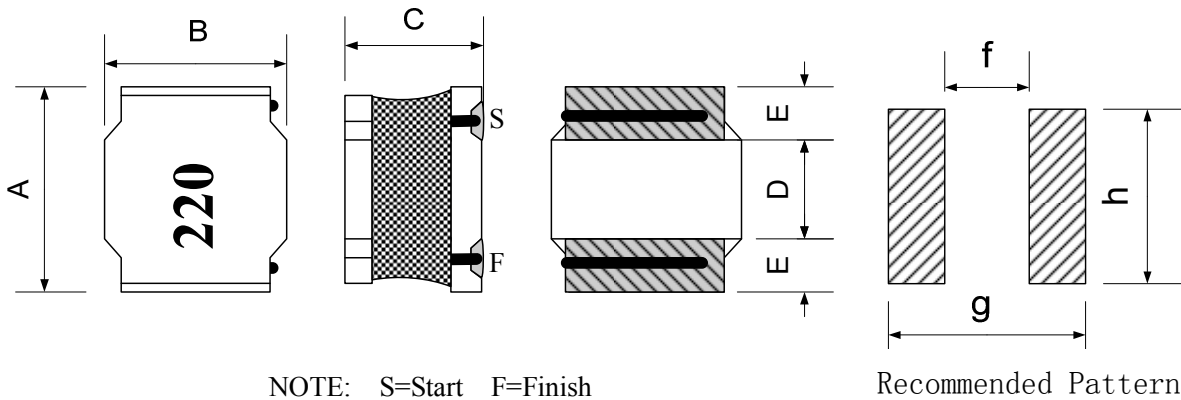
2. Product Identification

$\frac{\text{MPIT}}{\text{①}}$ $\frac{6045}{\text{②}}$ - $\frac{6R8}{\text{③}}$ $\frac{\text{M}}{\text{④}}$ - $\frac{\text{LF}}{\text{⑤}}$

- ① Product Symbol (T type SMD power inductor)
- ② Product dimensions (6.0×6.0×4.5mm)
- ③ Inductance Value: (4R7: 4.7uH 100: 10uH; 101: 100uH)
- ④ Inductance Tolerance: (M: ±20% ; N: ±30%)
- ⑤ Lead free product.

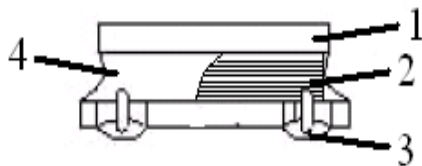
3. Appearance, Dimensions and Material

3.1 Appearance and dimensions



Dimensions in mm								
Model	A	B	C	D	E	f	g	h
MPIT6045	6.00±0.20	6.00±0.20	4.50 Max.	3.20 ±0.30..	1.40 ±0.30	2.80Typ.	6.20 Typ.	5.70Typ.

3.2 Material List



No.	Item	Material
1	Ferrite Core	Ni-Zn Ferrite
2	Wire	Enameled Copper Wire
3	Terminal Electrode	Ag/Ni/Sn/Cu
4	Magnetic Glue	Epoxy resin and magnetic powder

4. Testing Conditions

Unless otherwise specified

Temperature : Ordinary Temperature (5 to 35°C)
 Humidity : Ordinary Humidity (25 to 85% RH)
 Atmospheric Pressure : 86 to 106 kPa

In case of doubt

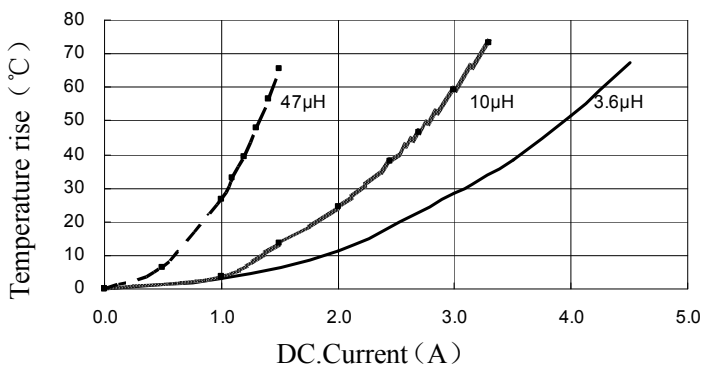
Temperature : 20±2°C
 Humidity : 60 to 75% RH
 Atmospheric Pressure : 86 to 106 kPa

5. Electrical Characteristics And Test Instruments

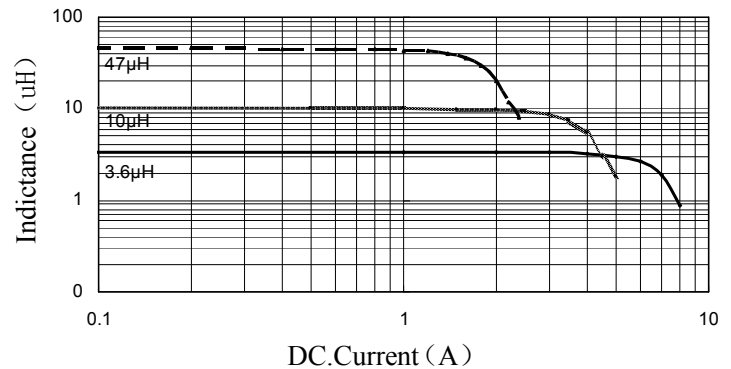
Microgate Part No.	Customer Part No.	Inductance (uH)	DCR (Ω) ±30%	Isat ^{*1} (A)	I _{rms} ^{*2} (A)	SRF (MHz)
MPIT 6045-R47N-LF		0.47±30%	0.006	14.00	6.40	160
MPIT 6045-R68N-LF		0.68±30%	0.007	12.30	6.20	150
MPIT 6045-R82N-LF		0.82±30%	0.008	12.35	5.90	140
MPIT 6045-1R0N-LF		1.0±30%	0.010	10.25	5.15	100
MPIT 6045-1R2N-LF		1.2±30%	0.010	9.50	5.40	100
MPIT 6045-1R5N-LF		1.5±30%	0.010	9.20	5.40	65
MPIT 6045-1R8N-LF		1.8±30%	0.012	7.70	4.95	74
MPIT 6045-2R2N-LF		2.2±30%	0.014	6.75	4.60	52
MPIT 6045-2R7N-LF		2.7±30%	0.015	6.35	4.30	38
MPIT 6045-3R0N-LF		3.0±30%	0.020	5.65	3.80	35
MPIT 6045-3R3N-LF		3.3±30%	0.021	5.95	3.70	32
MPIT 6045-3R6N-LF		3.6±30%	0.021	5.25	3.70	28
MPIT 6045-4R3M-LF		4.3±20%	0.023	4.85	3.45	23
MPIT6045-4R7M-LF		4.7±20%	0.026	4.95	3.30	24
MPIT6045-5R1M-LF		5.1±20%	0.026	4.50	3.30	23
MPIT6045-5R6M-LF		5.6±20%	0.029	4.30	3.15	23
MPIT6045-6R2M-LF		6.2±20%	0.030	3.90	3.05	26
MPIT6045-6R8M-LF		6.8±20%	0.031	3.95	3.00	20
MPIT6045-7R5M-LF		7.5±20%	0.036	3.80	2.85	18
MPIT6045-8R2M-LF		8.2±20%	0.043	3.80	2.60	21
MPIT6045-9R1M-LF		9.1±20%	0.044	3.40	2.65	17
MPIT6045-100M-LF		10±20%	0.047	3.20	2.50	15
MPIT6045-120M-LF		12±20%	0.055	3.00	2.30	13
MPIT6045-150M-LF		15±20%	0.068	2.60	2.05	12
MPIT6045-180M-LF		18±20%	0.078	2.20	1.90	10
MPIT6045-220M-LF		22±20%	0.089	2.10	1.80	10
MPIT6045-270M-LF		27±20%	0.105	1.90	1.65	9.2
MPIT6045-300M-LF		30±20%	0.132	1.70	1.50	7.8
MPIT6045-330M-LF		33±20%	0.137	1.65	1.45	7.8
MPIT6045-360M-LF		36±20%	0.173	1.62	1.40	7.8
MPIT6045-390M-LF		39±20%	0.180	1.50	1.25	7.8
MPIT6045-430M-LF		43±20%	0.200	1.63	1.20	7.7
MPIT6045-470M-LF		47±20%	0.200	1.40	1.20	6.4

MPIT6045-510M-LF		51±20%	0.207	1.35	1.15	6.4
MPIT6045-560M-LF		56±20%	0.221	1.30	1.10	6.4
MPIT6045-620M-LF		62±20%	0.235	1.25	1.10	6.4
MPIT6045-680M-LF		68±20%	0.289	1.20	1.00	6.4
MPIT6045-750M-LF		75±20%	0.305	1.15	0.95	5.0
MPIT6045-820M-LF		82±20%	0.341	1.05	0.90	4.9
MPIT6045-910M-LF		91±20%	0.359	1.00	0.85	4.9
MPIT6045-101M-LF		100±20%	0.433	0.95	0.80	4.2
MPIT6045-121M-LF		120±20%	0.484	0.85	0.77	4.2
MPIT6045-151M-LF		150±20%	0.580	0.80	0.70	4.2
MPIT6045-221M-LF		220±20%	0.834	0.70	0.59	3.5
MPIT6045-331M-LF		330±20%	1.270	0.57	0.57	2.8

T-I characteristic curve



L-I characteristic curve



Test instruments and remarks

* CHROMA 3302 meter for L and DCR./CHROMA 3302 and 1320 meter for IDC.

* L test condition: 100KHz&1V at 20°C ambient;

* Rated current: Isat or Irms, whichever is smaller:

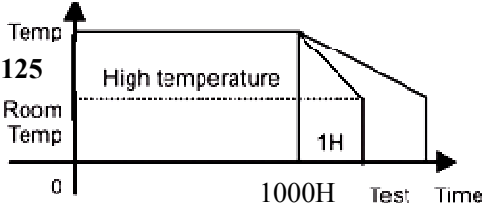
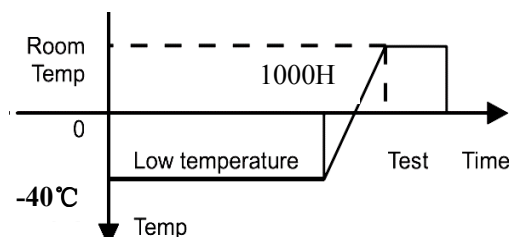
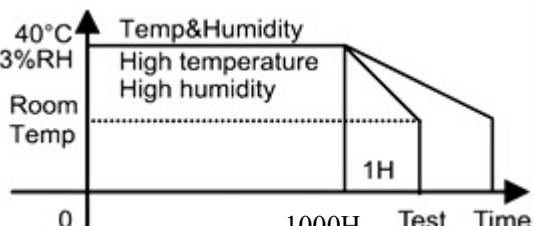
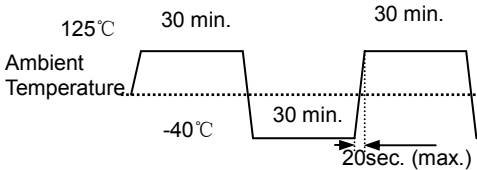
¹: Isat: direct current at which the inductance drops approximate 30% from its value without current.

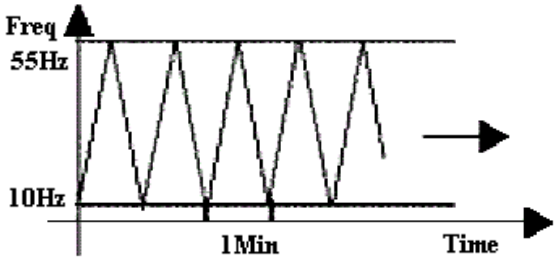
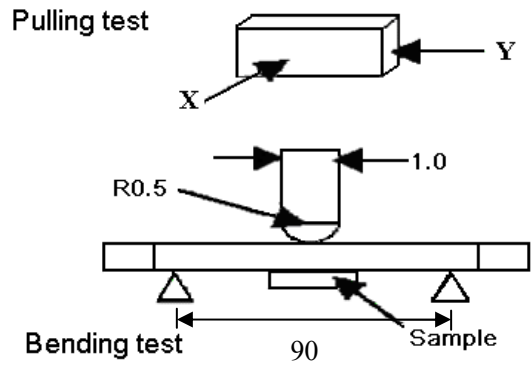
²: Irms: direct current when the temperature of the product rise ($\Delta T = 40^\circ\text{C}$) from 20°C ambient.

6. Condition of work

1. The part normal work be allowed ambient temperature: $-25^\circ\text{C} \sim +85^\circ\text{C}$.
2. The part must be allowed high temperature: $+125^\circ\text{C}$.
3. The part normal work be allowed temperature dependent: 40°C
4. Ambient temperature of the part is allowed storage temperature: $-25^\circ\text{C} \sim +85^\circ\text{C}$.
5. Storage life: half a year
6. The part be allowed work ambient frequency: $0.1\text{MHz} \sim 1\text{MHz}$

7. Reliability and Test Condition

Item	Required Characteristics	Test Method/Condition
High temperature resistance		Temperature: $85\pm 2^{\circ}\text{C}$ Time : 1000 hours Tested not less than 1 hours, nor more than 2 hours at room temperature. 
Low temperature resistance	1. No case deformation or change in appearance. 2. $ \Delta L /L \leq 10\%$	Temperature : $-25\pm 2^{\circ}\text{C}$ Time : 1000 hours Tested not less than 1 hour, nor more than 2 hours at room temperature. 
Humidity test		1. Exposure : Temperature: $60\pm 2^{\circ}\text{C}$, Humidity : $93\pm 3\%$ RH Time : 1000 hours. 2. Tested while the specimens are still in the chamber. 3. Tested not less than 1 hour, nor more than 2 hours at room temperature. 
Thermal shock test	1. No case deformation or change in appearance. 2. $ \Delta L /L \leq 10\%$	First -40°C for T time, last 125°C T time as 1 cycle. Go through 100 cycles. 

Item	Required Characteristics	Test Method/Condition
Solderability test	Terminal area must have 90% min. solder coverage.	Dip pads in flux then dip in solder pot at $245 \pm 5^{\circ}\text{C}$ for < 5 second. Solder: lead free Flux: rosin flux.
Heat endurance of reflow soldering		Refer to the next page reflow curve Go through 3 times. The peak temperature: $260 + 5 / - 0^{\circ}\text{C}$
Vibration test	1. No case deformation or change in appearance. 2. $ \Delta L/L \leq 10\%$	Apply frequency 10~55Hz. 1.5mm amplitude in each of perpendicular direction for 2 hours in each 3 mutually perpendicular directions.(total 6 hours) 
Drop test		Packaged & drop down from 1m with $981\text{m/s}^2(100\text{G})$ attitude in 1 angle 1 ridges & 2surfaces orientations.
Terminal strength test	Push Pulling test: Define: Solder the products on testing PCB using eutectic solder. Then apply a force in the direction of the arrow. 10N force. Keep time $\geq 5\text{s}$ Bending test: Soldering the products on PCB, after the pulling test and bending test, terminal should not pull off.	Bend the testing PCB at middle point, the deflection shall be 2mm. Pressurizing Speed: 0.5mm/sec, Keep time: $30 \pm 1\text{s}$, 
Resistance to solvent test	No case deformation or change in appearance, or obliteration of marking	To dip parts into IPA solvent for 50.5Min, then drying them at room temp for 5Min., at last, to brushing marking 10 times.
Loading Under Humidity Heat	1. No case deformation or change in appearance. 2. $ \Delta L/L \leq 10\%$	1. Exposure : Temperature: $60 \pm 2^{\circ}\text{C}$, Humidity : $93 \pm 3\%$ RH Time : 1000 hours. Apply rated current 2. Tested while the specimens are still in the chamber. 3. Tested not less than 1 hour, nor more than 2 hours at room temperature.
Loading at High Temperature	1. No case deformation or change in appearance. 2. $ \Delta L/L \leq 10\%$	1. Temperature: $85 \pm 2^{\circ}\text{C}$ 2. Time : 1000 hours 3. Apply rated current 4. Tested not less than 1 hours, nor more than 2 hours at room temperature.

8. Recommended Soldering Conditions

Product can be applied to flow and reflow soldering.

(1) Flux, Solder

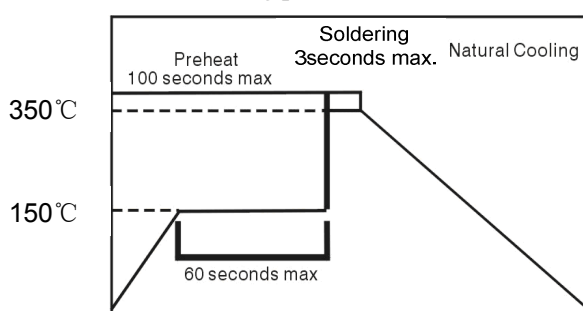
① Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).

② Use Sn solder.

(2) Flow soldering conditions

① Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100°C max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.

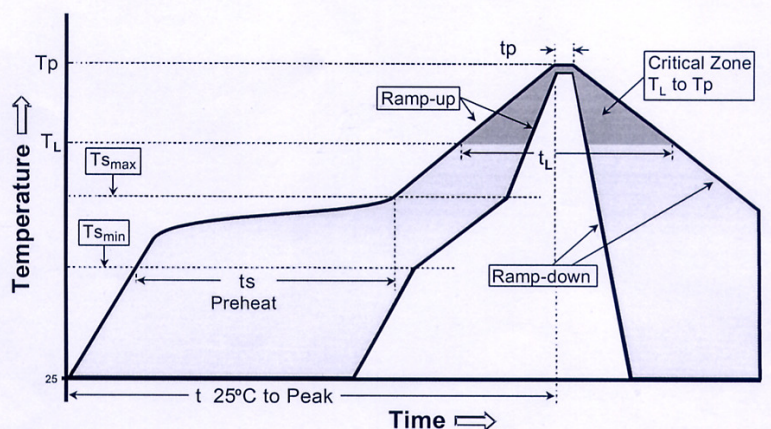
② Standard soldering profile.



Pre-heating	150°C, 1 minute min
Peak	350°C, 3 seconds max

(3) Reflow soldering conditions

Reflow curve



Profile Feature		Lead-Free Assembly
Average Ramp-Up Rate (Ts max. to Tp)		3°C /C/second max.
Preheat	- Temperature Min (Ts min.)	150 °C
	- Temperature Max (Ts max.)	200 °C
	- Time (ts min to ts max.)	60-180 seconds
Time maintained above	- Temperature (TL)	217 °C
	- Time (tL)	60-150 seconds
Peak/Classification Temperature (Tp)		260 °C
Peak/Classification Time (Tp)		3-4 seconds
Time within 5 °C of actual Peak Temperature (Tp)		20-40 seconds
Ramp-Down Rate		6°C/second max.
Time 25 °C to Peak Temperature		8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

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(4) The method on Re-work with using the iron:

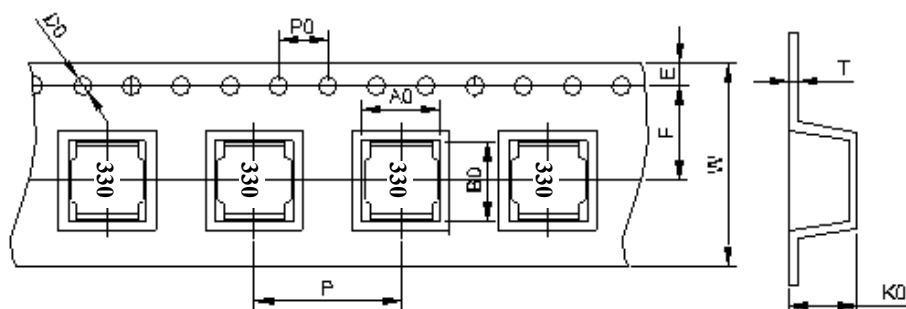
The following conditions must be strictly followed when using a soldering iron

Pre-heating	150°C, 1 minute
Tip temperature	350°C max
Soldering iron output	80w max
End of soldering iron	φ1mm max
Soldering time	3 seconds max

Product once removes from the circuit board may not be used again.

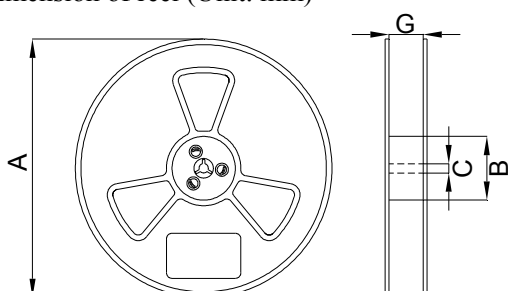
9. Package Information

9.1 Dimension of tape (Unit: mm)



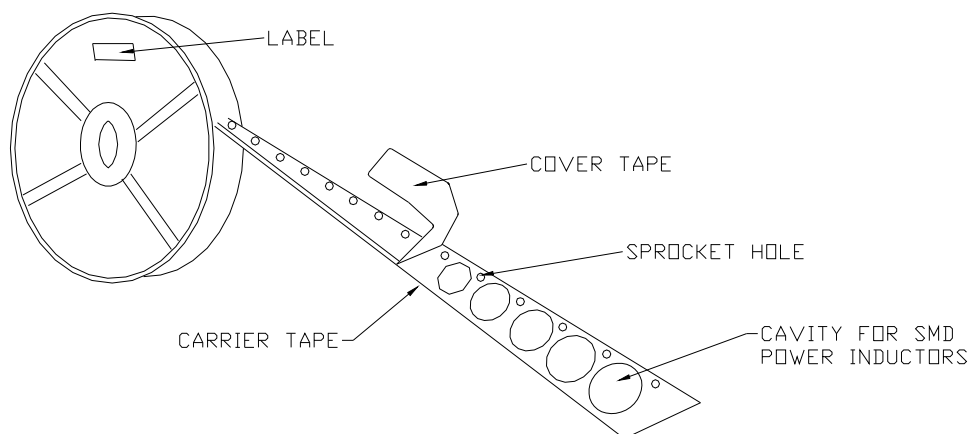
W	A0	B0	K0	E	F	P	P0	D0	T
16±0.3	6.4±0.1	6.4±0.1	4.8±0.1	1.75±0.1	7.5±0.1	8±0.1	4.0±0.1	1.5+0.1/-0.0	0.40±0.05

9.2 Dimension of reel (Unit: mm)



Symbol	Dimension
A	330±1
B	100±1
C	13±0.5
G	16.5±0.2

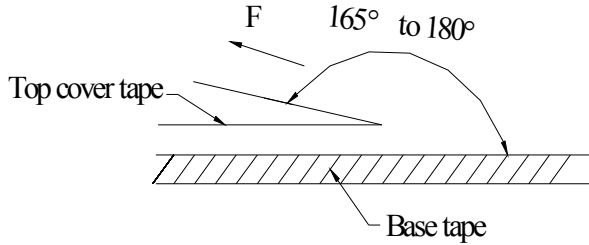
9.3 Taping figure and drawing direction



9.4 Packaging quantities:1500PCS/Reel.

9.5 Peeling strength of cover tape:

The peel force of top cover tape shall be between 0.1N to 1.3N



Room Temp. (°C)	Room Humidity (%)	Room aim (hpa)	Peel Speed Mm/min
5-35	45-85	860-1060	300

10. Visual inspection standard of product

No.	Defect Item	Graphic	Rejection identification	Acceptance
1	Core defect	A cross-sectional view of a component with a core defect. The width of the defect is labeled 'w' and the length is labeled 'l'. There are also smaller dimension lines indicating the thickness of the top and bottom layers.	$l > L/6$ or $w > W/6$, NG.	AQL=0.65
2	Missing resin	A cross-sectional view of a component showing a missing resin defect. The defect is represented by a shaded area where the resin is absent.	The area of missing resin more than 1/3single face, NG	AQL=0.65
3	Cold solder	A cross-sectional view of a component showing a cold solder defect. The length of the cold solder is labeled 'L'. The solder is shown as a thin, irregular layer on the surface.	L more than 1 mm, NG.	AQL=0.65
4	Solder uneven	A cross-sectional view of a component showing a solder uneven defect. The height of the solder is labeled 'H'. The solder is shown as a thick, uneven layer on the surface.	$H > 0.2\text{mm}$. NG.	AQL=0.65

11.Products Storage

(1) Storage period

Products which inspected in MICROGATE over 6 months ago should be examined and used, which can be confirmed with inspection No. marked on the container. Solderability should be checked if this period is exceeded.

(2) Storage conditions

Products should be storage in the warehouse on the following conditions:

Temperature: -10 ~+ 40°C

Humidity : Less than 80% relative and humidity

No rapid change on temperature and humidity

- (3) Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- (4) Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
- (5) Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- (6) Products should be storage under the airtight packaged condition.

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